

6. (amended) A system as claimed in claim 1, wherein the
electroconductive pins have a diameter below 3 mm, in particular
below 2 mm, and more in particular below 1.5 mm.

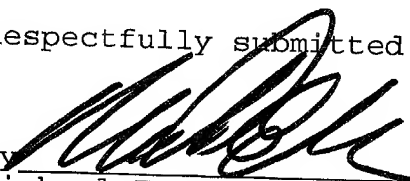
7. (amended) A method of manufacturing printed circuit boards
which are part of a system as claimed in claim 1, wherein the
electroconductive pins are formed by material removal, in
particular milling or drilling, from one printed circuit board.

REMARKS

The foregoing Preliminary Amendment to the claims were made
solely to avoid filing the claims in the multiple dependant form so
as to avoid the additional filing fee.

The claims were not amended in order to address issues of
patentability and Applicant respectfully reserves all rights he may
have under the Doctrine of Equivalents. Applicant furthermore
reserves his right to reintroduce subject matter deleted herein at
a later time during the prosecution of this application or
continuing applications.

Respectfully submitted,

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APPENDIX

Amended Claims

3. (amended) A system as claimed in claim 1 ~~or 2~~, wherein the inner surface of the recesses is coated on all sides with an electroconductive material, in particular a metal.
4. (amended) A system as claimed in claim 2 ~~or 3~~, wherein the electroconductive material is provided by means of electrolysis.
5. (amended) A system as claimed in claim 2, ~~3 or 4~~, wherein the thickness of the electroconductive material ranges between 25 μm and 40 μm , and is in particular approximately 35 μm .
6. (amended) A system as claimed in ~~any one of the preceding claims 1 through 5~~ claim 1, wherein the electroconductive pins have a diameter below 3 mm, in particular below 2 mm, and more in particular below 1.5 mm.
7. (amended) A method of manufacturing printed circuit boards which are part of a system as claimed in ~~any one of the preceding claims 1 through 6~~ claim 1, wherein the electroconductive pins are formed by material removal, in particular milling or drilling, from one printed circuit board.